



Matt Hicks

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Matt Hicks is the Sr. Director of Northrop Grumman's Foundries, Test & Advanced Packaging (FTAP) organization. This organization consists of the Advanced Technologies Labs (ATL; based in Linthicum Heights, MD), Space Park Foundry (SPF; based in Redondo Beach, CA) and Advanced Packaging (based in Linthicum Heights, MD, Redondo Beach, CA and Apopka, FL).

FTAP facilities designs, fabricates, packages, and tests discriminating microelectronic devices that provide enabling system capabilities for defense applications. The FTAP organizations have been delivering microelectronics for over 75 years, with annual deliveries exceeding 1,000,000 devices per year, leveraging over 1,000 staff. FTAP is part of the larger Northrop Grumman Microelectronic Center (NGMC).

Hicks previously held positions within NG as a Director of ATL, Program Manager for Space Payloads and Program Manager for Microelectronics. Throughout his career, he has supported programs ranging from fiber optic laser detonators, weak-link sensors, DMEA Trusted Foundry programs, semiconductor heterogeneous integration, advanced-node semiconductor development & integration, digital drop-on-demand printing technology, and several restricted programs. The commonality is providing facilitation and program management support to bring nationally strategic programs from R&D maturity into scaled production. Hicks received his B.S. degree in Electrical Engineering / Microelectronic Engineering from Rochester Institute of Technology and his M.B.A. degree from Temple University.

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